

MAS1017

AM Receiver IC

- •Wide Supply Voltage Range
- Power Down and Power Up Control

DESCRIPTION

The MAS1017 AM-Receiver chip is a highly sensitive, simple to use AM receiver specially intended to receive time signals in the frequency range from 40 kHz to 100 kHz. There are only a few external components needed. The circuit has a preamplifier, wide range

automatic gain control, demodulator and output comparator built in. The output signal can be processed directly with an additional digital circuitry to extract the data from the received signal.

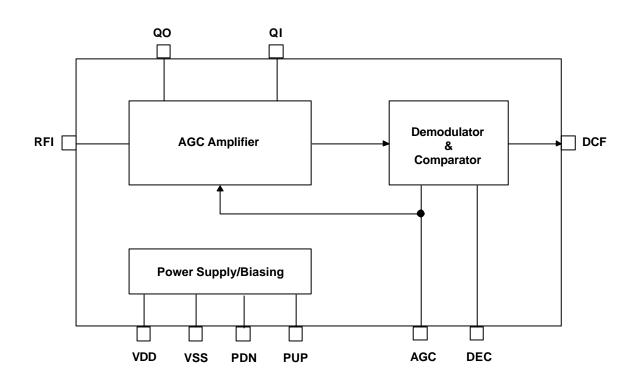
FEATURES

- Wide Supply Voltage Range
- Power Down and Power Up Control
- Only a Few External Components Needed
- Highly Sensitive AM Receiver

APPLICATIONS

• Time Signal Receiver (designed for DCF77)

BLOCK DIAGRAM





PAD LAYOUT

2	N	Q	4	п	ır	n
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	QI	DCF
E	QO	PUP
1588 μm	PD	AGC
`	RFI	DEC
	VSS	VDD

DIE size = 2.09×1.59 mm; PAD size = 100×100 μ m Substrate is connected to VDD. Please make sure that VDD is bonded first.

Pad Identification	Name	X-coordinate	Y-coordinate	Note
Power Supply Voltage	VDD	1867 μm	270 μm	
Power Supply Ground	VSS	262 μm	257 μm	
Power Down Input	PDN	242 μm	751 μm	1
Power Up Input	PUP	1859 μm	1029 μm	2
AGC Capacitor	AGC	1859 μm	790 μm	
Demodulator Capacitor	DEC	1859 μm	514 μm	
Receiver Input	RFI	242 μm	513 μm	
Quarz Filter Output	QO	242 μm	1029 μm	
Quarz Filter Input	QI	242 μm	1307 μm	
DCF Signal Output	DCF	1859 μm	1345 μm	3

Notes:

- Level = VSS means receiver on; VDD = receiver off (PUP = VSS) Internal pull-up resistor > 1 MOhm to VDD
- 2) Level = VDD means receiver on; VSS = receiver off (PDN = VDD) Internal pull-down resistor > 1MOhm to VSS
- 3) 100% AM results in Level = VSS; 25% AM results in Level = VDD
 - the output is a current source/sink with $|I_{OUT}| > 5 \mu A$
 - at power down the output is tri-state



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions	Min	Max	Unit
Supply Voltage	V_{DD} - V_{SS}		-0.3	5.0	V
Input Voltage	V _{IN}		V _{SS} -0.3	V _{DD} +0.3	V
Power Dissipation	P _{MAX}			100	mW
Operating Temperature	T _{OP}		-20	70	°C
Storage Temperature	T _{ST}		-40	120	°C

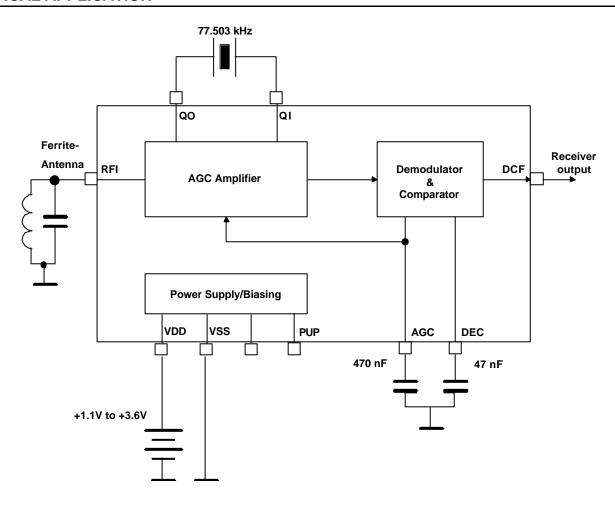
ELECTRICAL CHARACTERISTICS

Operating Conditions: VDD = 1.4V, Temperature = 25°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating Voltage	V_{DD}		1.10		3.60	V
Current Consumption	I _{DD}			40	100	μΑ
Stand-By Current	I _{DDoff}				0.1	μΑ
Input Range	f _{IN}		40		100	kHz
Sensitivity	V _{IN}		0.001		20	mVrms
Input Levels $ I_{IN} $ <0.5 μ A	V _{IL} V _{IH}		V _{DD} - 0.3		0.3	V
Output Current V _{OL} <0.2 V _{DD} ;V _{OH} >0.8 V _{DD}	ll _{OUT}		5			μΑ
Output Pulse	T ₀		30		125	ms
	T ₁		130		220	ms
Startup Time	T _{Start}			8		S
Output Delay Time	T _{Delay}			50		ms

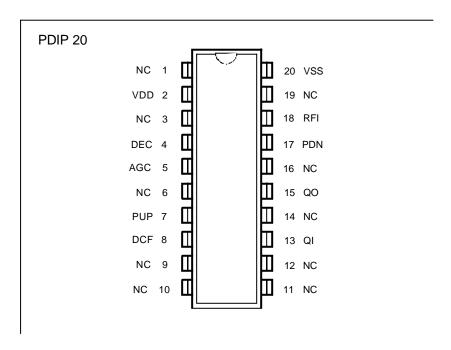


TYPICAL APPLICATION





PACKAGE (an example, see ordering information)



PIN DESCRIPTION

Pin Name	Pin	Type	Function	Note
NC	1			
VDD	2	Р	Positive power supply	
NC	3			
DEC	4	AO	Demodulator capacitor	
AGC	5	AO	AGC capacitor	
NC	6			
PUP	7	Al	Power up input	2
DCF	8	DO	Demodulator output	3
NC	9			
NC	10			
NC	11			
NC	12			
QI	13	Al	Quartz filter input	
NC	14			
QO	15	AO	Quartz filter output	
NC	16			
PDN	17	Al	Power down input	1
RFI	18	Al	Receiver input	
NC	19			
VSS	20	G	Power supply ground	

Notes:

- 1) Level = VSS means receiver on; VDD = receiver off
- 2) Level = VDD means receiver on; VSS = receiver off (PDN = VDD) Internal pull-down resistor > 1MOhm to VSS
- 3) 100 % AM results in Level = VSS; 25 % AM results in Level = VDD
 - the output is a current source/sink with [lout] >5 μA
 - at power down the output is tri-state



ORDERING INFORMATION

Product Code	Product	Package	Comments
MAS1017AZAA	AM-Receiver IC	Dice on sticky tape	
MAS1017ATAA	AM-Receiver IC	Wafer, EWS-tested	

More package options (e.g., SO14) available upon request.

LOCAL DISTRIBUTOR				

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